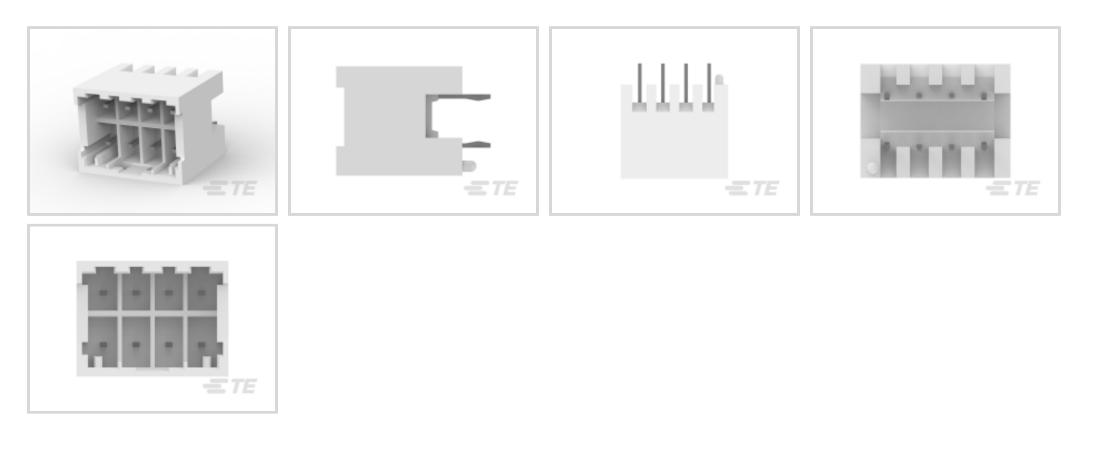


GRACE INERTIA 3.3 TE Internal #: 1827393-1 Rectangular Power Connectors, Header, Receptacle, Wire-to-Board, 8 Position, .129 in [3.3 mm] Centerline, Printed Circuit Board, GRACE INERTIA 3.3

View on TE.com >

Connectors > Power Connectors > Rectangular Power > Rectangular Power Connectors > Glow Wire GRACE INERTIA Header



Rectangular Power Connector Type: Header Connector & Housing Type: Receptacle

Connector System: Wire-to-Board

Number of Positions: 8

Centerline (Pitch): 3.3 mm [.129 in]

All Glow Wire GRACE INERTIA Header (68)



Features

Product Type Features

Header Type	Fully Shrouded
Rectangular Power Connector Type	Header
Connector & Housing Type	Receptacle
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	8
Keying	A
PCB Mount Orientation	Vertical
Number of Power Positions	8
Number of Signal Positions	2
Number of Rows	2

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Rectangular Power Connectors, Header, Receptacle, Wire-to-Board, 8 Position, .129 in [3.3 mm] Centerline, Printed Circuit Board, GRACE INERTIA 3.3



Electrical Characteristics

Operating Voltage	250 VDC
Contact Features	
Contact Layout	Matrix
Contact Underplating Material	Nickel
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	4 A
Contact Retention Within Housing	With
Contact Type	Таb
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	.8 μm[31.49 μin]
Underplate Material Thickness	1.27 μm[50 μin]
Contact Termination Area Plating Thickness	.8 μm[31.496 μin]
Tab Width	.7 mm[.028 in]
Termination Features	

118 in]

Termination Method to Wire & Cable	Crimp
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Strain Relief	Without
Mating Alignment Type	Keyed
Mating Alignment	With
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	With
PCB Mount Retention Type	Kinked
Connector Mounting Type	Board Mount
Mating Retention	With
Mating Retention Type	Latch
Housing Features	
Centerline (Pitch)	3.3 mm[.129 in]

Rectangular Power Connectors, Header, Receptacle, Wire-to-Board, 8 Position, .129 in [3.3 mm] Centerline, Printed Circuit Board, GRACE INERTIA 3.3



Housing Color	Natural
Housing Material	Nylon 6/6 GF
Dimensions	
Wire Size	414.44 – 1045.97 CMA
Row-to-Row Spacing	5.2 mm[.205 in]
PCB Thickness (Recommended)	.06 mm[1.6 in]
Height	13.4 mm[.527 in]
Length	11.6 mm[.456 in]
Usage Conditions	
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Glow Wire Rating	GWT 750°C (Without Flame)
Packaging Features	
Packaging Method	Box & Tray

Packaging Quantity

300

Other

For Use With

Plug Housing

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.

Rectangular Power Connectors, Header, Receptacle, Wire-to-Board, 8 Position, .129 in [3.3 mm] Centerline, Printed Circuit Board, GRACE INERTIA 3.3



Solder Process Capability

Wave solder capable to 265°C

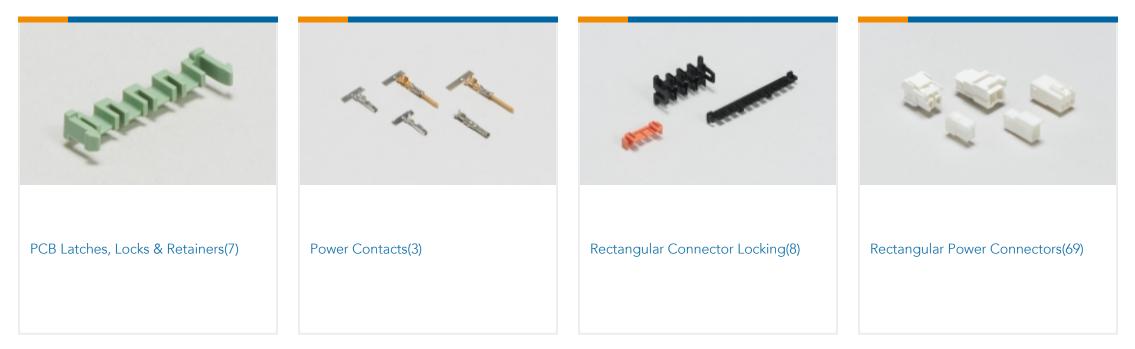
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



Also in the Series | GRACE INERTIA 3.3



Customers Also Bought



Rectangular Power Connectors, Header, Receptacle, Wire-to-Board, 8 Position, .129 in [3.3 mm] Centerline, Printed Circuit Board, GRACE INERTIA 3.3





Documents

Product Drawings GIC 3.3 HDR ASSY 8P

English

CAD Files

Customer View Model

ENG_CVM_CVM_1827393-1_G.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1827393-1_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1827393-1_G.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications GRACE INERTIA CONNECTOR 3.3 W-B

Japanese

Product Specification

Japanese

Product Environmental Compliance TE Material Declaration

English